Specification of Thermoelectric Module

TES1-17760

Description

The 177 couples single module which is 2 pieces 16.7 mm \times 34.2 mm size wired together and made of selected high performance ingot to achieve superior cooling performance and greater delta T up to 74 °C, designed for superior cooling and heating up to 100/200 °C applications. If higher operation or processing temperature is required, please specify, we can design and manufacture the custom made module according to your special requirements.

Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

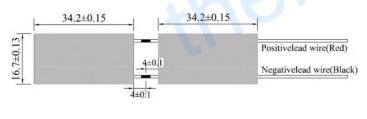
Performance Specification Sheet

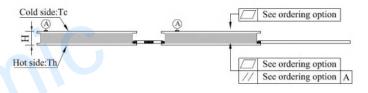
Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂
DT _{max} (°C)	74	83	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U _{max} (Voltage)	23.4	25.2	Voltage applied to the module at DT _{max}
I _{max} (amps)	7.0	7.0	DC current through the modules at DT _{max}
Q _{Cmax} (Watts)	104.2	113.7	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (ohms)	2.54	2.73	The module resistance is tested under AC
Tolerance (%)	±10		For thermal and electricity parameters

Geometric Characteristics Dimensions in millimeters





Ordering Option

Suffix	Thickness	Flatness/	Lead wire length(mm)		
	H (mm)	Parallelism (mm)	Standard/Optional length		
TF	$0{:}2.8\pm0.1$	0: 0.08/0.08	150±3/Specify		
TF	$1{:}2.8\pm0.03$	1: 0.03/0.03	150±3/Specify		
Eg. TF01: Thickness 2.8 ± 0.1 (mm) and Flatness $0.03/0.03$ (mm)					

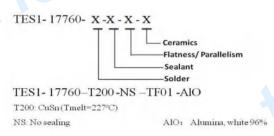
Manufacturing Options

2. Aluminum Nitride (AlN)

A. Solder:	B. Sealant:
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant
C. Ceramics:	D. Ceramics Surface Options:
1. Alumina (Al ₂ O ₃ , white 96%) \sim	1. Blank ceramics (not metalized)

- 1. Blank ceramics (not me
 - 2. Metalized

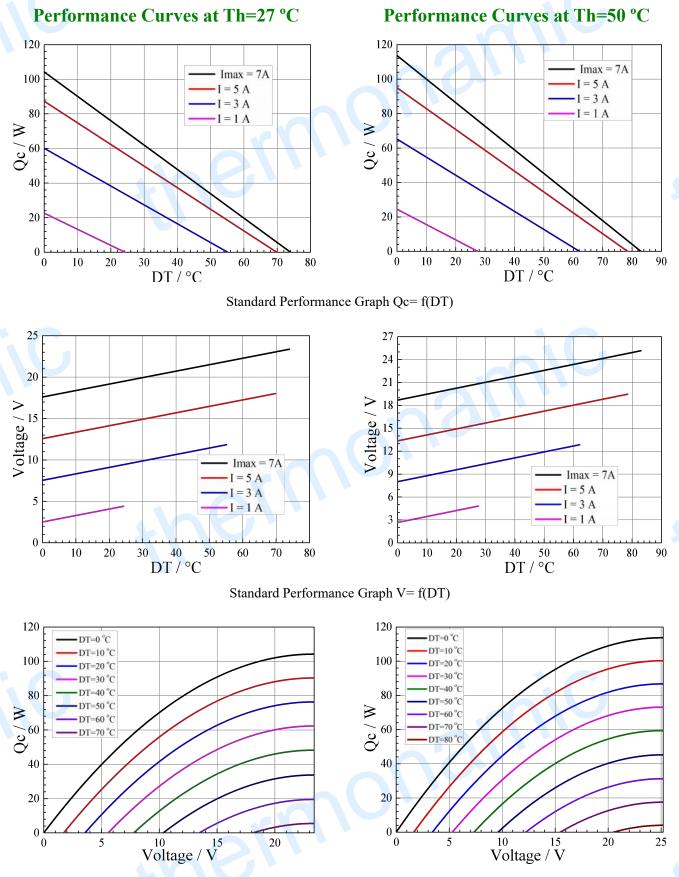
Naming for the Module



Creative technology with fine manufacturing processes provides you the reliable and quality products Tel: +86-791-88198288 Fax: +86-791-88198308 Email: <u>sales@thermonamic.com.cn</u> Web Site: www.thermonamic.com.cn

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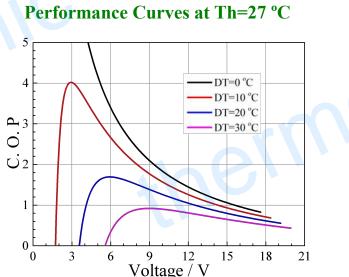


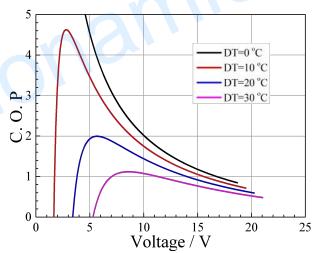
Standard Performance Graph Qc=f(V)

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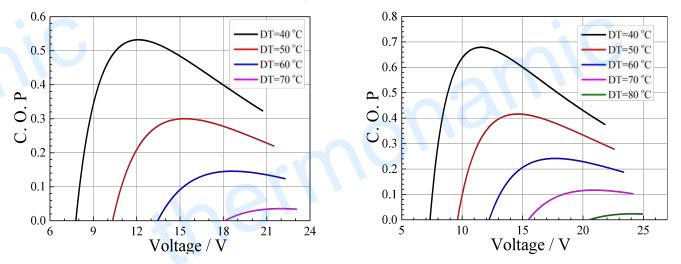
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Performance Curves at Th=50 °C

Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C



Standard Performance Graph COP = f(V) of DT ranged from 40 to 70/80 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power ($V \times I$).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.